

**• General Description**

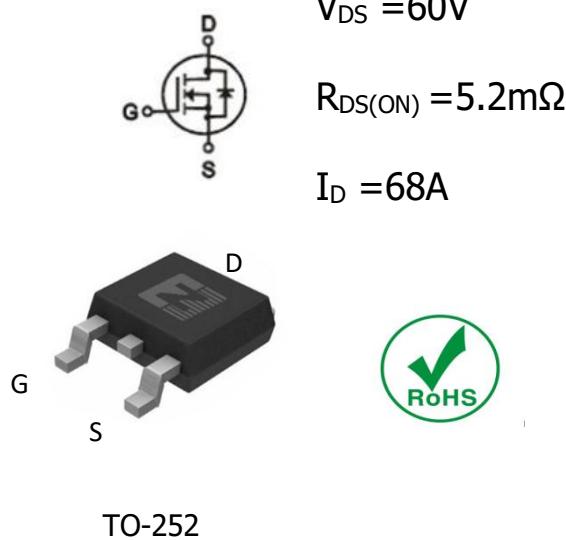
It combines advanced MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

• Features

- Advance device construction
- Low $R_{DS(ON)}$ to minimize conduction loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

- Synchronous Rectification for AC-DC/DC-DC converter
- Power Tools

• Product Summary $V_{DS} = 60V$ $R_{DS(ON)} = 5.2m\Omega$ $I_D = 68A$

TO-252

• Ordering Information:

Part NO.	ZMS052N06D
Marking	ZMS052N06
Packing Information	REEL TAPE
Basic ordering unit (pcs)	2500

• Absolute Maximum Ratings ($T_c = 25^\circ C$)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	$I_D@T_c=25^\circ C$	68	A
	$I_D@T_c=75^\circ C$	52	A
	$I_D@T_c=100^\circ C$	43	A
Pulsed Drain Current ^①	I_{DM}	50	A
Total Power Dissipation	$P_D@T_c=25^\circ C$	50	W
Total Power Dissipation	$P_D@T_A=25^\circ C$	1.25	W
Operating Junction Temperature	T_J	-55 to 150	$^\circ C$
Storage Temperature	T_{STG}	-55 to 150	$^\circ C$
Single Pulse Avalanche Energy	E_{AS}	280	mJ

**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}			2.1	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	62.5	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	60			V
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250uA	1.5		2.5	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			1.0	uA
Gate- Source Leakage Current	I _{GSS}	V _{GS} =±20V ,V _{DS} =0V			±100	nA
Static Drain-source On Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =10A		5.2	6.5	mΩ
		V _{GS} =4.5V, I _D =5A		6.8	8.5	mΩ
Forward Transconductance	g _{Fs}	V _{DS} =25V, I _D =10A		16		s
Source-drain voltage	V _{SD}	I _S =10A			1.28	V

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C _{iss}	f = 1MHz V _{DS} =25V	-	1910	-	pF
Output capacitance	C _{oss}		-	1070	-	
Reverse transfer capacitance	C _{rss}		-	22	-	

•Gate Charge characteristics(T_a = 25°C)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q _g	V _{DD} = 25V I _D = 8A V _{GS} = 10V	-	24	-	nC
Gate - Source charge	Q _{gs}		-	5	-	
Gate - Drain charge	Q _{gd}		-	3.3	-	

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;



ZMJ SEMICONDUCTOR CO., LTD

ZMS052N06D
60V N-Channel SpeedFET™

Fig.1 Gate-Charge Characteristics

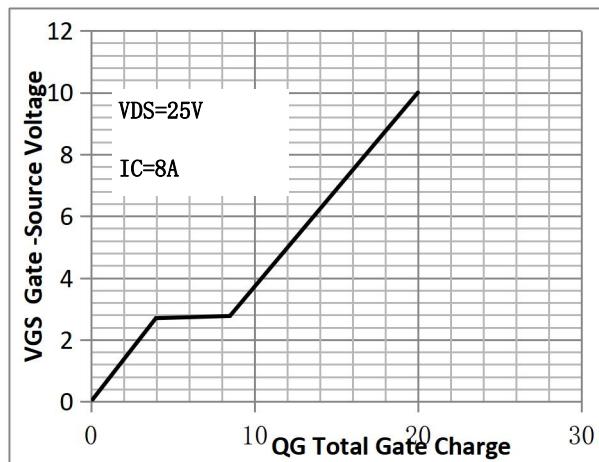


Fig.2 Capacitance Characteristics

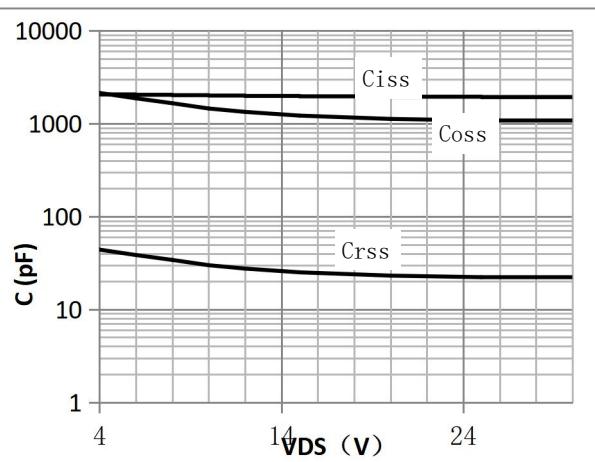


Fig.3 Power Dissipation

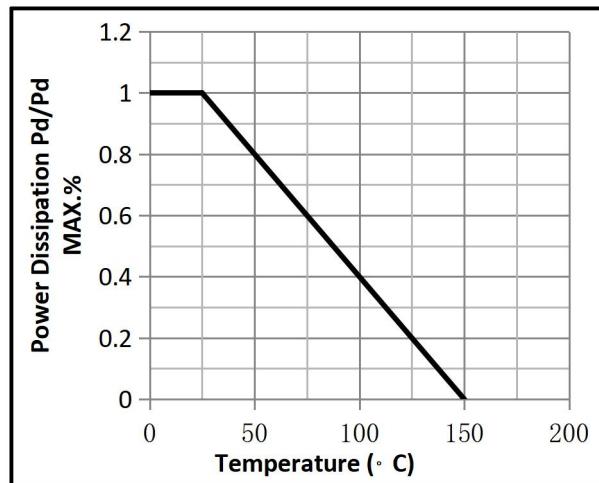


Fig.4 Typical output Characteristics

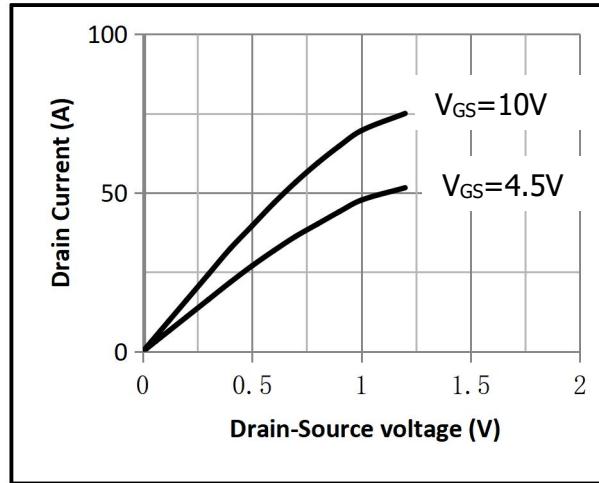


Fig.5 Threshold Voltage V.S Junction Temperature

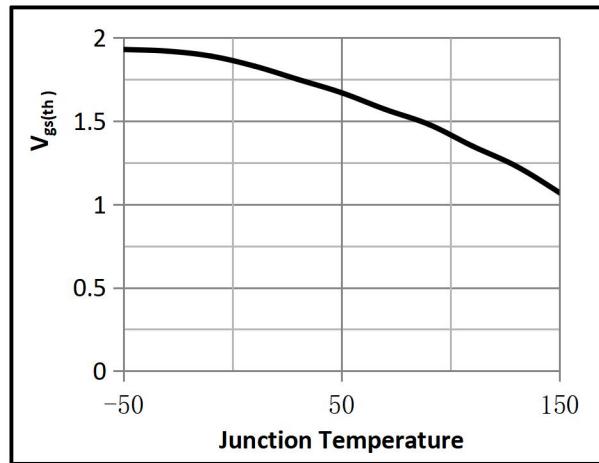


Fig.6 Resistance V.S Drain Current

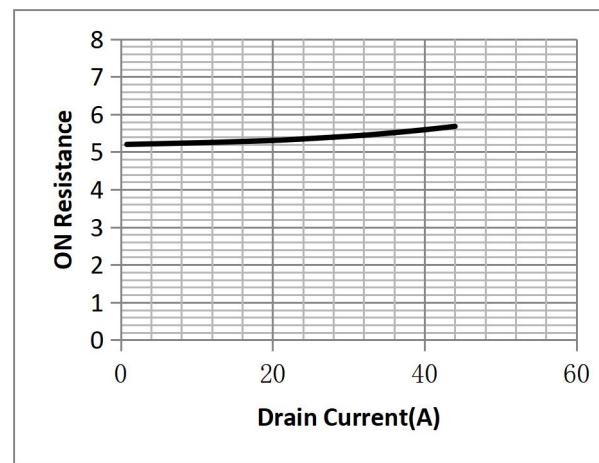




Fig.7 On-Resistance VS Gate Source Voltage

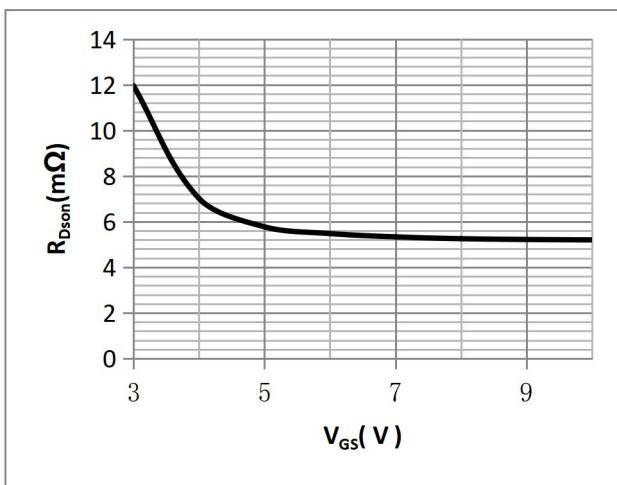


Fig.8 On-Resistance V.S Junction Temperature

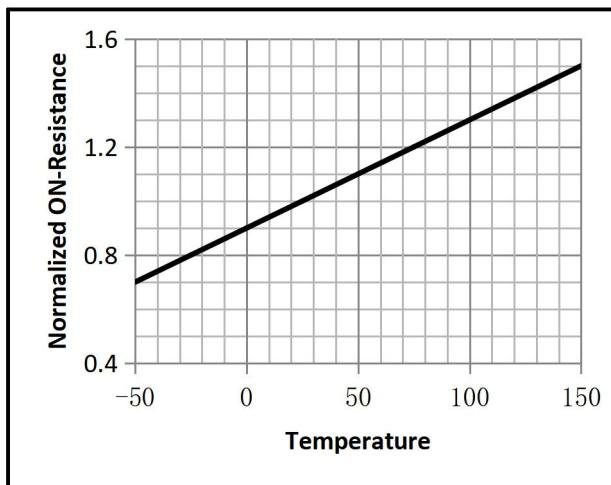


Fig.9 SOA Maximum Safe Operating Area

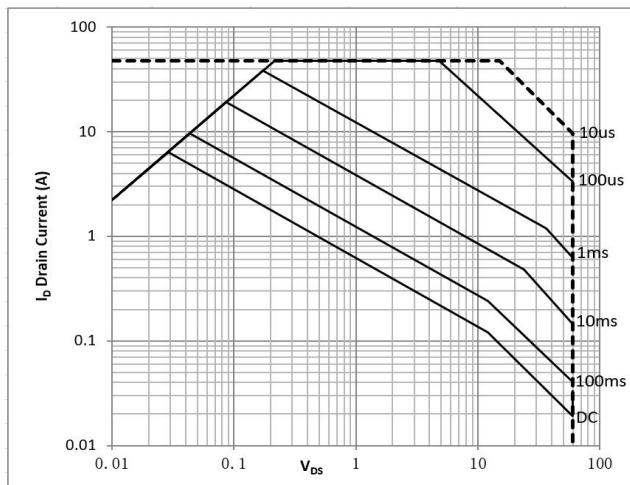


Fig.10 ID-Junction Temperature

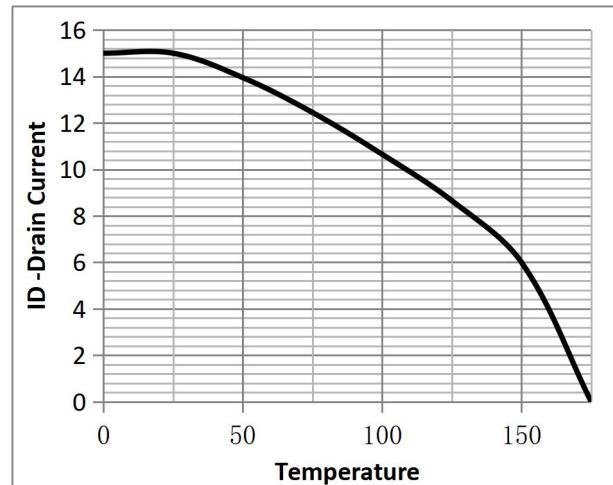


Fig.11 Switching Time Measurement Circuit

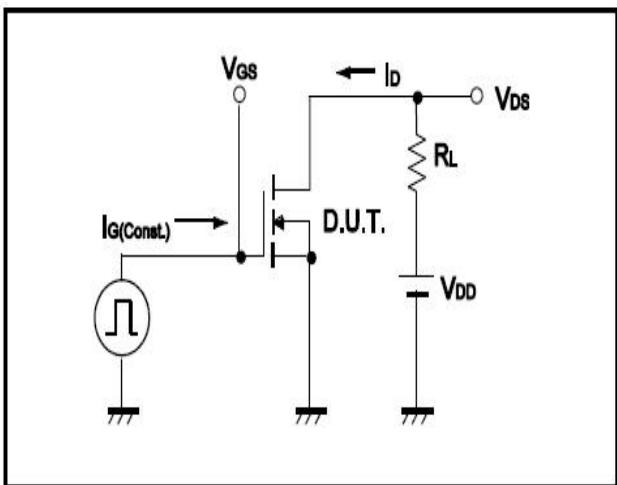


Fig.12 Gate Charge Waveform

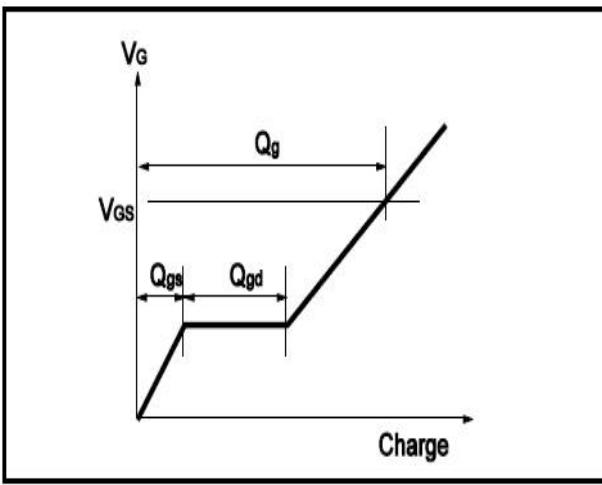




Fig.13 Switching Time Measurement Circuit

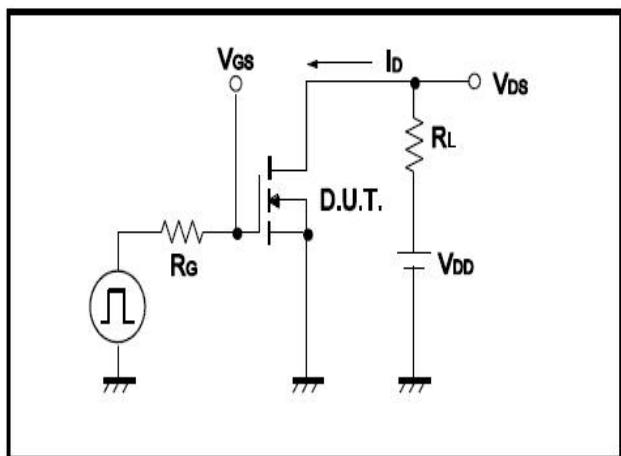
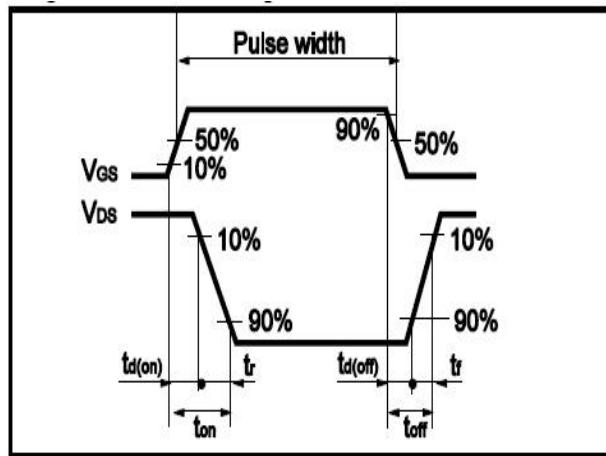


Fig.14 Gate Charge Waveform





•Dimensions(TO-252)

Unit: mm

SYMBOL	min	max	SYMBOL	min	max
A	2.10	2.50	B	0.85	1.25
b	0.50	0.80	b1	0.50	0.90
b2	0.45	0.70	C	0.45	0.70
D	6.30	6.75	D1	5.10	5.50
E	5.30	6.30	e1	2.25	2.35
L1	9.20	10.60	e2	4.45	4.75
L2	0.90	1.75	L3	0.60	1.10
K	0.00	0.23			

